

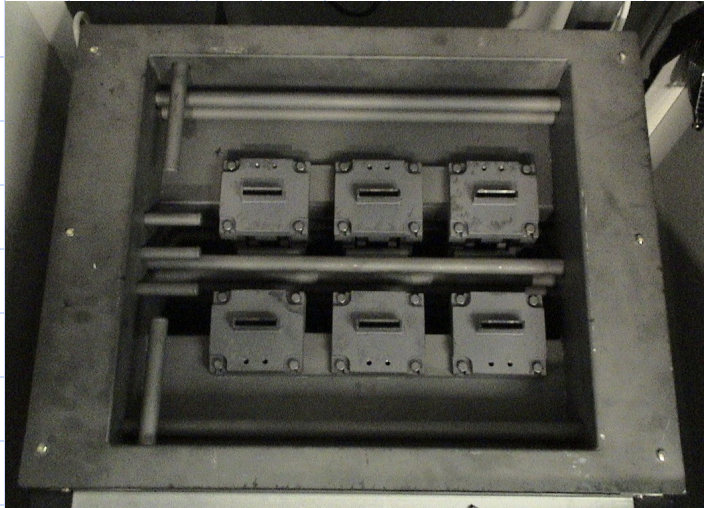
Selective Soldering System Stand – alone model TPD6-25



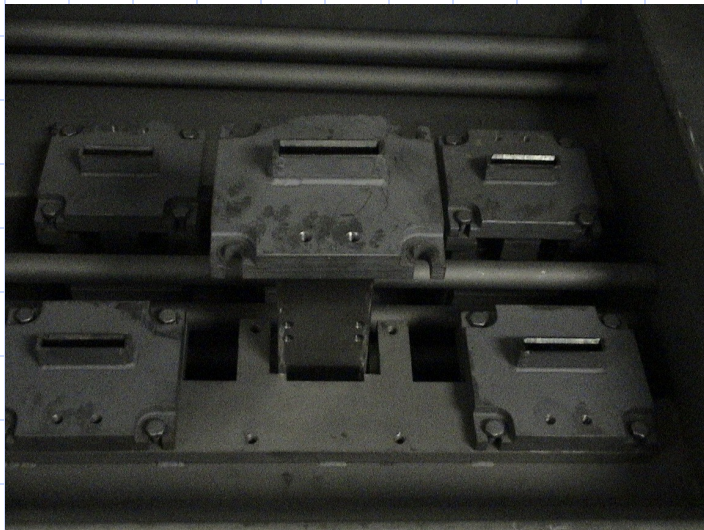
- ◆ Most efficient application
- ◆ Selective spray fluxer with precision needle point
 - ◆ Six individual FLIP units –individually programmable

Selective Soldering System

Flip Solder Flow System



- Six Individual FLIP
 - Individual programmable
- Sp Coating
 - Reduce corrosion



- Easy Core removable
 - Maintenance

Specification

Applicable boards	:	MAX. 330(W)×400(L)mm. / MIN. 50(W)×50(L)mm
Parts clearance	:	Top MAX. 150mm / Bottom MAX. 25mm
Circuit board height allowance	:	3 mm
Parts to other parts clearance	:	5 mm
Solder bath	:	6 Flip (Flat Linear Induction Pump)
Input source	:	AC200V,208V,220V,480V,3φ 14kVA at 200V
Weight	:	approx. 300kg

Control Box

Centralized control for electric machinery and instrument of whole equipment (sequence controller)

Digital display and control

Solder Temperature

Alarm display

Display



0 ~ 260 degrees

Emergency stop
Solder bath overheat

Language can be switched between Japanese and English

Selective Solder and Flux unit

